ABP2 SERIES

Board Mount Pressure Sensors

High Accuracy, Compensated/Amplified 6 mbar to 12 bar | 600 Pa to 1.2 MPa | 2 inH₂O to 175 psi Digital or Analog Output, Liquid Media Capable

DESCRIPTION

The ABP2 Series are piezoresistive silicon pressure sensors offering a digital or analog output for reading pressure over the specified full scale pressure span and temperature range. They are calibrated and temperature compensated for sensor offset, sensitivity, temperature effects and accuracy errors (which include non-linearity, repeatability and hysteresis) using an on-board Application Specific Integrated Circuit (ASIC). Calibrated output values for pressure and temperature are updated at approximately 200 Hz. All products are designed and manufactured according to ISO 9001 standards. The liquid media option includes an additional gel coating to protect the electronics under port P1, which enables use with non-corrosive liquids (e.g. water and saline) and in applications where condensation can occur. The ABP2 Series is available in tube packaging. Pocket tape and reel packaging is available upon request.

APPLICATIONS

- Medical: Ventilators/portable ventilators, CPAP, blood analysis, blood pressure monitoring, breast pumps, drug dosing, hospital beds, massage machines, oxygen concentrators, patient monitoring, sleep apnea equipment, urine analyzers and wound therapy
- Industrial: HVAC transmitters, life sciences, material handling, pneumatic control and regulation, process gas monitoring and valve positioning/positioners

- Commercial: Air beds, coffee makers, washing machines, level measurement, dish washers, vacuum cleaners, hand dryers and rice cookers
- Transportation: Air brakes,
 CNG monitoring, fork lifts and fuel level measurement

FEATURES

- Total Error Band (see Figure 1):
 - As low as ± 1.5 %FSS
- Liquid media option:
 - Compatible with a variety of liquid media
- Long-term stability:
 - As low as ± 0.2 %FSS
- Accuracy:
 - ±0.25 %FSS BFSL
- Wide pressure range:
 - 6 mbar to 12 bar
 - 600 Pa to 1.2 MPa
 - 2 inH₂O to 175 psi
- High burst pressures
- Wide operating temperature range of -40°C to 110°C [-40°F to 230°F]
- Calibrated over wide temperature range of -40°C to 110°C [-40°F to 230°F]
- 24-bit digital I²C or SPI-compatible output
- Ratiometric analog output
- IoT (Internet of Things) ready interface
- Ultra-low power consumption:
 - As low as 0.01 mW typ. average power
 - 1 Hz measurement frequency
- Meets IPC/JEDEC J-STD-020E Moisture Sensitivity Level 1
- REACH and RoHS compliant
- Temperature output available
- NSF-169, LFGB and BPA compliant materials









PORTFOLIO

Honeywell offers a variety of board mount pressure sensors for use in medical and industrial applications. To view the entire product portfolio, click here.



ABP2 SERIES

VALUE TO CUSTOMERS

- Simplifies design-in:
 - Small size saves room on the PC board (PCB), simplifying design in smaller and lower power devices
- Meets IPC/JEDEC J-STD-020E Moisture Sensitivity Level 1 requirements:
 - Allows avoidance of thermal and mechanical damage during solder reflow attachment and/or repair that lesser rated sensors may incur
 - Allows for unlimited shelf life when stored at <30°C/85 %RH (simplifying storage and reducing scrap)
 - Eliminates lengthy bakes prior to reflow
 - Allows for lean manufacturing due to stability and usability shortly after reflow
- · Cost-effective:
 - Small size helps engineers reduce design and manufacturing costs while maintaining enhanced performance and reliability of the systems they design
- Accurate:
 - Total Error Band (TEB) and wide pressure range enable engineers to optimize system performance by improving resolution and system accuracy
- Flexible:
 - Supply voltage range, variety of pressure units, types and ranges, output options, and wide operating temperature range simplify use in the application
- Versatile:
 - Wet-media compatibility, low power, and temperature output options make the sensor a versatile choice for Internet of Things applications

DIFFERENTIATION

- Application:
 - Specific design ensures suitability for a wide array of customer requirements
- Digital output:
 - Allows the sensor to be directly plugged into the customer's circuitry without requiring major design changes
- Total Error Band (see Figure 1):
 - Provides a more comprehensive measurement of performance over the compensated temperature range, which minimizes testing and calibrating every sensor, thereby potentially reducing manufacturing cost; improves sensor accuracy and offers ease of sensor interchangeability due to minimal part-to-part variation
 - Improves sensor accuracy
 - Offers ease of sensor interchangeability due to minimal part-to-part variation

TABLE OF CONTENTS

U		11 LI113				
4	Tota	al Error Band				
5	General Specifications					
8 8 10 11	Power Consumption and Standby Mode Digital Output Versions Analog Output Versions Nomenclature and Order Guide					
12	Pres	ssure Range Specifications				
20	Dim	ensional Drawings				
27	1.0	General Information				
27	2.0	Pinout and Functionality				
27	3.0	Start-Up Timing				
27	4.0	Power Supply Requirement				
28 28 28 28	5.1 5.2	Reference Circuit Design Digital Output Versions Analog Output Versions Bypass Capacitor Use				
29 29 29 29 29 30 30 31 32	6.1 6.2 6.3 6.4 6.5 6.6 6.7	I2C Communications I2C Bus Configuration I2C Data Transfer I2C Sensor Address I2C Pressure and Temperature Reading I2C Status Byte I2C Communications I2C Timing and Level Parameters Reference Code (Arduino/Genuino Uno) for I2C Interface				
33 33 34 33 35 36 37	7.1 7.2 7.3 7.4	SPI Data Transfer SPI Pressure and Temperature Reading SPI Status Byte SPI Communications				
38 39	8.0 8.1	ABP2 Series Calculations Digital Output Versions				

40 8.2 Analog Output Versions

41 9.0 Recommended Pneumatic Sensor Connections

42 9.1 Tubing

42 9.2 O-ring Manifold Designs

Back cover Additional Information

ABP2 SERIES

TOTAL ERROR BAND

Total Error Band (TEB) is a single specification that includes the major sources of sensor error. TEB should not be confused with accuracy, which is actually a component of TEB. TEB is the worst error that the sensor could experience.

Honeywell uses the TEB specification in its datasheet because it is the most comprehensive measurement of a sensor's true accuracy. Honeywell also provides the accuracy specification in order to provide a common comparison with competitors' literature that does not use the TEB specification.

Many competitors do not use TEB—they simply specify the accuracy of their device. Their accuracy specification, however, may exclude certain parameters. On their datasheet, the errors are listed individually. When combined, the total error (or what would be TEB) could be significant.

Figure 1. Total Error Band

Sources of Error

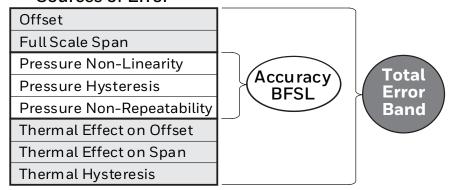


TABLE 1. ABSOLUTE MAXIMUM SPECIFICATIONS ¹							
Characteristic	Minimum	Maximum	Unit				
Supply voltage (V _{supply}): digital output analog output	-0.3 -0.3	3.6 6.0	Vdc				
Voltage on any pin	-0.3	V _{supply} + 0.3	Vdc				
Digital clock frequency: I ² C SPI	100 50	400 800	kHz				
ESD susceptibility (human body model)	2	_	kV				
Storage temperature range	-40 [-40]	125 [257]	°C[°F]				
Soldering time and temperature: lead (DIP)							

¹Absolute maximum ratings are the extreme limits the device will withstand without damage.

TABLE 2. OPERATING SPECIFICATIONS							
Characteristic		Analog		Digital			Unit
Characteristic	Minimum	Typical	Maximum	Minimum	Typical	Maximum	Onit
Supply voltage (V _{supply}) ¹ 3.3 Vdc 5.0 Vdc	3.0 4.75	3.3 5.0	3.6 5.25	1.8	3.3	3.6	Vdc
Current consumption: I ² C sleep/standby mode SPI sleep/standby mode	3.0 13.0	33.8 43.8	211.0 221.0	3.0 13.0	33.8 43.8	211.0 221.0	nA
Power consumption	_	9.5	_	_	3.1	_	mW
Operating temperature range ²	-40 [-40]	_	110 [230]	-40 [-40]	_	110 [230]	°C [°F]
Compensated temperature range ³	-40 [-40]	_	110 [230]	-40 [-40]	_	110 [230]	°C [°F]
Startup time ⁴	_	_	5	_	_	2.5	ms
Clipping limit for analog version: Upper Lower	- 2.5	_ _	97.5 —	_ _	_ _	_ _	V_{supply}
Update/data rate	_	1000	_	161	204	_	Samples/s
SPI/I ² C voltage level: Low High	_ _	_ _	_ _	- 80	_ _	20 –	%V _{supply}
Pull up on SDA, SCL	_	_	_	1	_	_	kOhm
Total Error Band⁵: 0°C to 50°C -20°C to 85°C -40°C to 110°C	_ _ _	_ _ _	±1.5 ±3.0 ±4.5	_ _ _	_ _ _	±1.5 ±3.0 ±4.5	%FSS ⁶ %FSS ⁶ %FSS ⁶
Accuracy ⁷	_	_	±0.25	_	-	±0.25	%FSS BFSL
Resolution	0.03	_	_ _	_ 14	_	_ _	%FSS bits
Temperature output error ⁸	_	_	_	_	±5	_	°C

¹Sensors are not reverse polarity protected. Incorrect application of supply voltage or ground to the wrong pin may cause electrical failure.

² Operating temperature range: The temperature range over which the sensor will produce an output proportional to pressure.

³ Compensated temperature range: The temperature range over which the sensor will produce an output proportional to pressure within the specified performance limits (see Total Error Band).

⁴ Startup Time: For analog versions: 5 ms to data ready. For digital versions: 2.5 ms for power up to receive the first measurement command. Refer to Section 3.0, Tables 21, 22 and 25 for further details on communication timing.

⁵Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range. Includes all errors due to offset, full scale span, pressure non-linearity, pressure hysteresis, repeatability, thermal effect on offset, thermal effect on span and thermal hysteresis.

⁶ Full Scale Span (FSS): The algebraic difference between the output signal measured at the maximum (Pmax.) and minimum (Pmin.) limits of the pressure range (see Figure 2).

Accuracy: The maximum deviation in output from a Best Fit Straight Line (BFSL) fitted to the output measured over the pressure range at 25°C [77°F]. Includes all errors due to pressure non-linearity, pressure hysteresis and non-repeatability.

⁸ Temperature Output Error: The error in Temperature Output reading relative to a thermal reference standard over a temperature range of -40°C to 125°C.

TABLE 3. ENVIRONMENTAL SPECIFICATIONS						
Characteristic	Parameter					
Humidity: all external surfaces internal surfaces of liquid media options "T", "V", "G" and "F" internal surfaces of dry gases options "N" and "D"	0 %RH to 95 %RH, non-condensing 0 %RH to 100 %RH, condensing 0 %RH to 95 %RH, non-condensing					
Vibration	15 g, 10 Hz to 2 kHz					
Shock	75 g, 6 ms duration					
Life ¹	1 million full scale pressure cycles minimum					
Solder reflow	J-STD-020-E Moisture Sensitivity Level 1 (unlimited shelf life when stored at \leq 30°C/85 %RH)					
Certification (silicone gel coating option, Port 1 only) ²	NSF169, BPA Free, LFGB					

 $^{^{\}rm 1}{\rm Life}$ may vary depending on specific application in which the sensor is utilized.

²Sensor materials have been tested and certified for the food safety standards noted.

TABLE 4. WETTED MATERIALS ¹						
Component	Pressure Port 1 (P1)	D D 2 (D2)				
	Dry Gas Option	Liquid Media Option	Pressure Port 2 (P2)			
Ports and covers	High temperature polyamide, 304	High temperature polyamide				
Substrate	FR4	_	FR4			
Adhesives	Epoxy, silicone	Epoxy, silicone gel, fluorosilicone gel	Epoxy, silicone			
Electronic components	Silicon, glass, gold, aluminum	_	Silicon			

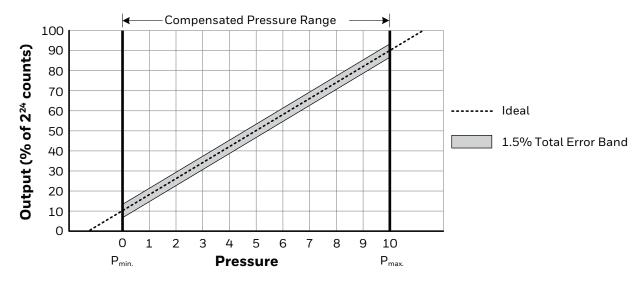
 $^{^{\}rm 1}$ Contact Honeywell customer service for detailed material information.

TABLE 5. SENSOR PRESSURE TYPES					
Pressure Type	Description				
Absolute	Output is proportional to the difference between pressure applied and a built-in vacuum reference.				
Differential	Output is proportional to the difference between the applied pressure to each port (Port1 - Port2)				
Gage	Output is proportional to the difference between applied pressure and atmospheric (ambient) pressure.				

TABLE 6. SENSOR OUTPUT AT SIGNIFICANT PERCENTAGES						
	Digital Versions		Analog Versions			
Output (%)	Counts		V _{SUPPLY}			
	Decimal	Hex	3.3 V	5.0 V		
0	0	0X000000	0.0	0.0		
10	1677722	OX19999A	0.33	0.5		
30	5033165	0X4CCCCC	0.99	1.5		
50	8388608	0X800000	1.65	2.5		
70	11744051	OXB33333	2.31	3.5		
90	15099494	0XE66666	2.97	4.5		
100	16777215	OXFFFFFF	3.3	5.0		

ABP2 SERIES

Figure 2. Transfer Function for Digital Output Versions



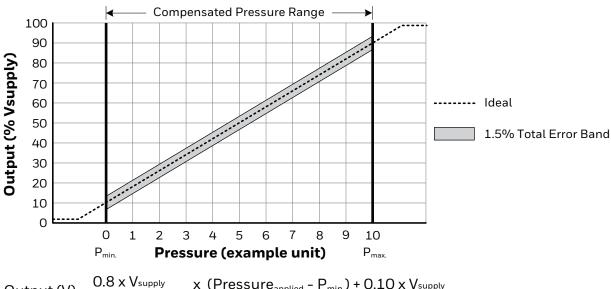
Pressure example 1: Transfer Function A (10% to 90%)

Output (% of
$$2^{24}$$
 counts) = $\frac{80\%}{P_{\text{max.}} - P_{\text{min.}}} \times (Pressure_{\text{applied}} - P_{\text{min.}}) + 10\%$

Pressure example 2: Transfer Function B (30% to 70%)

Output (% of
$$2^{24}$$
 counts) = $\frac{40\%}{P_{\text{max.}} - P_{\text{min.}}}$ x (Pressure_{applied} - $P_{\text{min.}}$) + 30%

Figure 3. Transfer Function for Analog Output Versions



Output (V) =
$$\frac{0.8 \times V_{\text{supply}}}{P_{\text{max.}} - P_{\text{min.}}} \times (Pressure_{\text{applied}} - P_{\text{min.}}) + 0.10 \times V_{\text{supply}}$$

ABP2 SERIES

POWER CONSUMPTION AND STANDBY MODE

DIGITAL OUPTUT VERSIONS

The sensor is normally in Standby Mode and is only turned on in response to a user command, thus minimizing power consumption. Upon receiving the user command, the sensor wakes up from Standby Mode, runs a measurement in Active State, and automatically returns to Standby Mode, awaiting the next command. The resulting sensor power consumption is a function of the sampling rate (samples per second) as shown in Tables 7 and 8 and Figures 4 and 5.

TABLE 7. DIGITAL OUTPUT VERSIONS AVERAGE POWER CONSUMPTION AT 1.8 V _{SUPPLY} (ASSUMES COMMAND AA _{HEX})									
Sampling Rate (samples per second)	Average Power (mW)	Active Time (ms)	Active Power (mW)	Idle Time (ms)	Idle Power (mW)				
Minimum Average Power									
1	0.0068	3.625	1.884	996.375	0.0000054				
2	0.0137	7.25	1.884	992.75	0.0000054				
5	0.0341	18.125	1.884	981.875	0.0000054				
10	0.0683	36.25	1.884	963.75	0.0000054				
20	0.1366	72.5	1.884	927.5	0.0000054				
50	0.3414	181.25	1.884	818.75	0.0000054				
100	0.6829	362.5	1.884	637.5	0.0000054				
160	1.0926	580	1.884	420	0.0000054				
Typical Average Powe	r								
1	0.0094	4.157	2.248	995.843	0.00006084				
2	0.0187	8.314	2.248	991.686	0.00006084				
5	0.0468	20.785	2.248	979.215	0.00006084				
10	0.0935	41.57	2.248	958.43	0.00006084				
20	0.1870	83.14	2.248	916.86	0.00006084				
50	0.4673	207.85	2.248	792.15	0.00006084				
100	0.9345	415.7	2.248	584.3	0.00006084				
160	1.4592	665.12	2.248	334.88	0.00006084				
Maximum Average Po	wer								
1	0.0129	4.839	2.588	995.161	0.0003798				
2	0.0254	9.678	2.588	990.322	0.0003798				
5	0.0630	24.195	2.588	975.805	0.0003798				
10	0.1256	48.39	2.588	951.61	0.0003798				
20	0.2508	96.78	2.588	903.22	0.0003798				
50	0.6264	241.95	2.588	758.05	0.0003798				
100	1.2524	483.9	2.588	516.1	0.0003798				
160	2.0036	774.24	2.588	225.76	0.0003798				

Figure 4. Digital Output Versions Average Power Consumption vs Sampling Rate at 1.8 V_{SUPPLY}

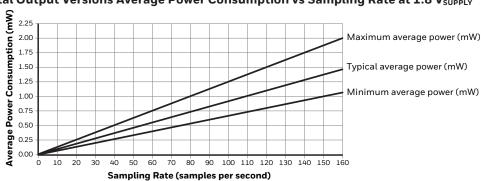
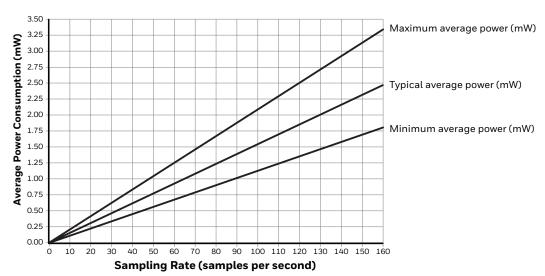


TABLE 8. DIGITAL OU	TABLE 8. DIGITAL OUTPUT VERSIONS AVERAGE POWER CONSUMPTION AT 3.3 V _{SUPPLY} (ASSUMES COMMAND AA _{HEX})								
Sampling Rate (samples per second)	Average Power (mW)	Active Time (ms)	Active Power (mW)	Idle Time (ms)	Idle Power (mW)				
Minimum Average Power									
1	0.0114	3.625	3.134	996.375	0.0000099				
2	0.0227	7.25	3.134	992.75	0.0000099				
5	0.0568	18.125	3.134	981.875	0.0000099				
10	0.1136	36.25	3.134	963.75	0.0000099				
20	0.2272	72.5	3.134	927.5	0.0000099				
50	0.5680	181.25	3.134	818.75	0.0000099				
100	1.1361	362.5	3.134	637.5	0.0000099				
160	1.8177	580	3.134	420	0.0000099				
Typical Average Powe	r								
1	0.0156	4.157	3.729	995.843	0.00011154				
2	0.0311	8.314	3.729	991.686	0.00011154				
5	0.0776	20.785	3.729	979.215	0.00011154				
10	0.1551	41.57	3.729	958.43	0.00011154				
20	0.3101	83.14	3.729	916.86	0.00011154				
50	0.7751	207.85	3.729	792.15	0.00011154				
100	1.5501	415.7	3.729	584.3	0.00011154				
160	2.4800	665.12	3.729	334.88	0.00011154				
Maximum Average Po	wer								
1	0.0214	4.839	4.275	995.161	0.0006963				
2	0.0421	9.678	4.275	990.322	0.0006963				
5	0.1041	24.195	4.275	975.805	0.0006963				
10	0.2075	48.39	4.275	951.61	0.0006963				
20	0.4144	96.78	4.275	903.22	0.0006963				
50	1.0349	241.95	4.275	758.05	0.0006963				
100	2.0692	483.9	4.275	516.1	0.0006963				
160	3.3103	774.24	4.275	225.76	0.0006963				

Figure 5. Digital Output Versions Average Power Consumption vs Sampling Rate at 3.3 VSUPPLY

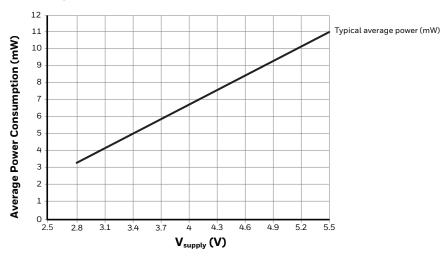


ABP2 SERIES

ANALOG OUTPUT VERSIONS (SEE TABLE 9 AND FIGURE 6.)

TABLE 9. ANALOG OUTPUT VERSIONS POWER CONSUMPTION							
Vsupply (V)	Active Power (mW)	Minimum Power (mW)	Average Power (mW)	Maximum Power (mW)			
2.8	3.36	3.3	3.4	3.5			
3.3	4.62	4.4	4.5	4.7			
5	9.5	9.1	9.2	9.4			
5.5	11	10.9	11.0	11.1			

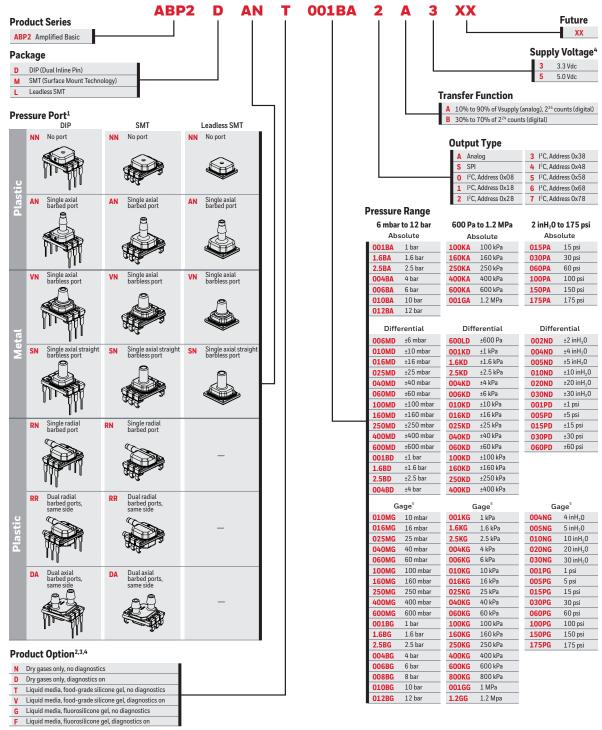
Figure 6. Analog Output Versions Average Power Consumption



ABP2 SERIES

Figure 7. Nomenclature and Order Guide

For example, ABP2DANT001BA2A3XX defines an ABP2 Series Amplified Basic Pressure Sensor, DIP package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, f 1 bar absolute pressure range, digital l 2 C, address 0x28 output type, 10 % to 90 % of 224 counts (digital) transfer function, 3.3 Vdc supply voltage.



¹The "DA" Pressure Port is only available with Product Options "N" and "D". The "DA" Pressure Port is available in standard listings with pressure ranges up to 400 mbar | ±160 mbar. For higher pressure ranges, please contact the technical support team.

⁷ Product Options "N" and "D" are only available with gage pressure ranges 10 mbar to 40 mbar | 1kPa to 4 kPa | 4 in-H₂O to 20 in-H₂O and differential pressure ranges ±6 mbar to ±25 mbar | ±1 kPa to ±2.5 kPa | ±2 in-H₂O to ±10 in-H₂O.

³ Product Options "T" and "V" are only available with pressure ranges 60 mbar | 6 kPa | 1 psi gage and ±40 mbar | ±4 kPa | 1 psi differential and above.

⁴⁵ Vdc supply voltage and diagnostic options are only available with analog output listings. They are not available with digital output listings.

 $^{^510}$ mbar, 1 kPa, and 4 in-H $_2$ 0 pressure ranges are limited to 11-bit resolution for analog output listings.

⁶ Ultra low pressure ranges less than 1 psi are not available as standard listing in leadless package, please contact the technical support team for such requests.

ABP2 series pressure sensors are piezo-resistive based which are sensitive to change in light intensity. These semiconductor materials when exposed to light, change the output resulting in sensor offset voltage. For applications where direct exposure to light is possible, we recommend Flurosilicone gel listings which are less susceptible to light transmitting to the sense die.

ABP2 SERIES

SELECT ABP2 SERIES SENSORS MOUNTED ON BREAKOUT BOARDS

Breakout boards, with or without the sensor premounted (see Figure 8 and Tables 10, 11, and 12) are designed for use with the Honeywell SEB Sensor Evaluation Kit.

Figure 8. APB2 Series Sensors and Breakout Boards

SN Leadless SMT sensor premounted on breakout board **Breakout board** (ABP2LSNT060PGSA3BB) (ABP2-BREAKOUT-BRD)

TABLE 10. ORDER GUIDE FOR ABP2 SERIES SENSORS AND BREAKOUT BOARDS					
Catalog Listing	Description				
ABP2MRRN004ND2B3BB	ABP2 Series sensor with SMT package, plastic dual radial barbed ports, same side pressure port, dry gases only, no diagnostics, ± 4 inH $_2$ O differential pressure range, I 2 C address 0x28, 30 % to 70 % of 2^{24} counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2MDAN004ND2B3BB	ABP2 Series sensor with SMT package, plastic dual axial barbed ports same side, dry gases only, no diagnostics, ± 4 inH $_2$ O differential pressure range, I 2 C address 0x28, 30 % to 70 % of 2 24 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2MVNT400MG2A3BB	ABP2 Series sensor with leaded SMT package, metal single axial tapered pressure port, liquid media, food-grade silicone gel, no diagnostics, 400 mbar gage pressure range, 12 C address 0x28, 10 % to 90 % of 224 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LANT001PG2A3BB	ABP2 Series sensor with leadless SMT package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, 1 psi gage pressure range, I^2C address 0x28, 10 % to 90 % of 2^{24} counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LSNT060PGSA3BB	ABP2 Series sensor with leadless SMT package, metal single axial straight barbless pressure port, liquid media, food-grade silicone gel, no diagnostics, 60 psi gage pressure range, SPI output type, 10 % to 90 % of 2^{24} counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LANT001BA2A3BB	ABP2 Series sensor with leadless SMT package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, 1 bar absolute pressure range, I^2C address 0x28, 10 %to 90 % of I^2 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2-BREAKOUT-BRD	Bare breakout board for use with SMT and leadless SMT packages with AN, SN, VN, NN, RN, or RR pressure ports				

ABP2 SERIES

SELECT ABP2 SERIES SENSORS MOUNTED ON BREAKOUT BOARDS (CONTINUED)

TABLE 11.	TABLE 11. BREAKOUT BOARD ASSEMBLY DETAILS						
SL Number	REF Designator	Description	Manufacturer Part Number	Populate	Description		
1	C1	Capacitor, ceramic, 0.1 μF, 16 V, X7R, 10 % SMD 0402	GCM155R71C104KA55J	Populated	A decoupling capacitor, breakout board shipped with this part assembled		
2	C2	Capacitor, ceramic SMD 0402	NA	DNP	Do not populate		
3	R1, R2	Resistor SMD 0402 SCL line/R1 and SDA line R2	NA	DNP	Optional pull-up resistors for I ² C output (not populated on the breakout board); recommended pull-up resistor value: 1 kOhm to 10 kOhm		
4	R3	Resistor, SMD 0402	NA	DNP	Jumper resistor, do not populate		
5	P1	Connector, header, 6 pin, straight, 2,54 mm pitch through hole	826629-6	Populated	6 pin connector		
6	U1	ABP2 sensor	ABP2	Populated	Respective ABP2 sensor mounted		

TABLE 12. BREAKOUT BOA	TABLE 12. BREAKOUT BOARD PINOUTS								
Pin Number	I ² C Output	SPI Output							
1	V_{DD}	V_{DD}							
2	SCL	SCLK							
3	EOC	MISO							
4	SDA	MOSI							
5	GND	GND							
6	NC	SS							

Duanauun		ssure nge		Overpre	ssure¹	Burst Pr	essure²	Common	Tota	al Error Ba (%FSS)	and ⁴	Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digita Versions
							Abs	olute						
001BA	0	1	bar	16	_	25	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
1.6BA	0	1.6	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
2.5BA	0	2.5	bar	16	-	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
				Differential										
006MD	-6	6	mbar	700	700	7000	1000	_	±2.0	±3.5	_	±1.0	±0.3	В
010MD	-10	10	mbar	700	700	7000	1000	_	±2.0	±3.5	_	±1.0	±0.3	В
016MD	-16	16	mbar	700	700	7000	1000	-	±2.0	±3.5	_	±1.0	±0.3	А
025MD	-25	25	mbar	700	700	7000	1000	_	±2.0	±3.5	_	±1.0	±0.3	А
040MD	-40	40	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	±1.0	±0.2	А
060MD	-60	60	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	±1.0	±0.2	А
100MD	-100	100	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	±1.0	±0.2	А
L60MD	-160	160	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	±1.0	±0.2	А
250MD	-250	250	mbar	16000	-	25000	-	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
400MD	-400	400	mbar	16000	-	25000	-	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
600MD	-600	600	mbar	16000	-	25000	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
001BD	-1	1	bar	16	-	25	-	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
1.6BD	-1.6	1.6	bar	16	-	25	_	16	±1.5	±3.0	±4.5	±1.0	±0.2	A
2.5BD	-2.5	2.5	bar	16	-	25	_	16	±1.5	±3.0	±4.5	±1.0	±0.2	A
004BD	-4	4	bar	16	_	25	-	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
							G	age						
010MG	0	10	mbar	700	-	7000	_	_	±2.0	±3.5	-	±1.0	±0.3	В
016MG	0	16	mbar	700	-	7000	-	_	±2.0	±3.5	-	±1.0	±0.3	В
025MG	0	25	mbar	700	-	7000	_	_	±2.0	±3.5	-	±1.0	±0.3	A
040MG	0	40	mbar	700	-	7000	-	_	±2.0	±3.5	_ _/L E	±1.0	±0.3	A
060MG 100MG	0	60 100	mbar	2000	_	7000 7000	_	_	±1.5 ±1.5	±3.0 ±3.0	±4.5	±1.0 ±1.0	±0.2	A
160MG	0	160	mbar	2000	_	7000	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
250MG	0	250	mbar	2000	_	7000	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
400MG	0	400	mbar	2000	_	7000	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
600MG	0	600	mbar	16000	_	25000	_	_	±1.5	±3.0	±4.5	±1.0	±0.6	A
001BG	0	1	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.5	Α
1.6BG	0	1.6	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.3	А
2.5BG	0	2.5	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
004BG	0	4	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
006BG	0	6	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
008BG	0	8	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
010BG	0	10	bar	16	_	25	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
012BG	0	12	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А

¹ **Overpressure:** The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² **Burst Pressure:** The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

^{*}Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

ABP2 Series Datasheet | sps.honeywell.com/ast | 14

TABLE 14	. PRE	SSURE	RAN	GE SPE	CIFICA	TIONS:	250 MB	AR TO 12 E	BAR FO	R PRO	DUCT	PTIONS	"G" AND "F	"ONLY
	Pres Rar	sure nge		Overpr	essure¹	Burst P	ressure²	Common	Tota	al Error B (%FSS)		Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digital Versions
							Ak	solute						
001BA	0	1	bar	16	-	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.6BA	0	1.6	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BA	0	2.5	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BA	0	4	bar	16	-	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
006BA	0	6	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
008BA	0	8	bar	16	-	25	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
010BA	0	10	bar	16	-	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
012BA	0	12	bar	16	-	25	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Diff	erential						
250MD	-250	250	mbar	16000	-	25000	_	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400MD	-400	400	mbar	16000	-	25000	-	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600MD	-600	600	mbar	16000	-	25000	_	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001BD	-1	1	bar	16	-	25	-	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.6BD	-1.6	1.6	bar	16	_	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BD	-2.5	2.5	bar	16	-	25	-	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BD	-4	4	bar	16	-	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							(Gage						
600MG	0	600	mbar	16000	_	25000	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001BG	0	1	bar	16	-	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.5BG	0	1.6	bar	16	_	25	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BG	0	2.5	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BG	0	4	bar	16	-	25	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
006BG	0	6	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
008BG	0	8	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
010BG	0	10	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
012BG	0	12	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

		ssure nge		Overpi	ressure¹	Burst	Pressure ²	Common	Tot	al Error E (%FSS		Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digita Versions
							Ab	solute						
LOOKA	0	100	kPa	1600	-	2500	-	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
60KA	0	160	kPa	1600	_	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
250KA	0	250	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
							Diff	ferential						
00LD	-600	600	Pa	70000	70000	70000	100000	-	±2.0	±3.5	-	±1.0	±0.3	В
01KD	-1	1	kPa	70	70	700	100	-	±2.0	±3.5	-	±1.0	±0.3	В
6KD	-1.6	1.6	kPa	70	70	700	100	-	±2.0	±3.5	_	±1.0	±0.3	А
2.5KD	-2.5	2.5	kPa	70	70	700	100	-	±2.0	±3.5	_	±1.0	±0.3	А
004KD	-4	4	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	±1.0	±0.2	А
006KD	-6	6	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	±1.0	±0.2	Α
10KD	-10	10	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	±1.0	±0.2	Α
)16KD	-16	16	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	±1.0	±0.2	А
25KD	-25	25	kPa	1600	_	2500	-	16000	±1.5	±3.0	±4.5	±1.0	±0.6	Α
40KD	-40	40	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	Α
60KD	-60	60	kPa	1600	_	2500	-	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
LOOKD	-100	100	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.2	Α
L60KD	-160	160	kPa	1600	_	2500	-	16000	±1.5	±3.0	±4.5	±1.0	±0.2	А
250KD	-250	250	kPa	1600	-	2500	-	16000	±1.5	±3.0	±4.5	±1.0	±0.2	Α
400KD	-400	400	kPa	1600	-	2500	-	16000	±1.5	±3.0	±4.5	±1.0	±0.2	Α
							(Gage						
001KG	0	1	kPa	70	_	700	_	_	±2.0	±3.5	-	±1.0	±0.3	В
L.6KG	0	1.6	kPa	70	_	700	_	_	±2.0	±3.5	_	±1.0	±0.3	В
2.5KG	0	2.5	kPa	70	_	700	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
004KG	0	4	kPa	70	_	700	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
006KG	0	6	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
010KG	0	10	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
016KG	0	16	kPa	200	_	700	-	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
025KG	0	25	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
040KG	0	40	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
060KG	0	60	kPa	1600	_	2500	_	_	±1.5	±3.0	±4.5	±1.0	±0.6	А
LOOKG	0	100	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.5	А
L60KG	0	160	kPa	1600	-	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
250KG	0	250	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
400KG	0	400	kPa	1600	_	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
600KG	0	600	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
воока	0	800	kPa	1600	-	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
001GG	0	1	MPa	1.6	-	2.5	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
L.2GG	0	1.2	MPa	1.6	_	2.5	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² **Burst Pressure:** The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

ABP2 Series Datasheet | sps.honeywell.com/ast | 16

TABLE 16. PRESSURE RANGE SPECIFICATIONS: 25 KPA TO 1.2 MPA FOR PRODUCT OPTIONS "G" AND "F" ONLY														
		sure nge		Overpr	essure¹	Burst Pi	ressure ²	Common	Tota	al Error B (%FSS)		Typical Offset	Long- term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digital Versions
							Ab	solute						
100KA	0	100	kPa	1600	-	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
160KA	0	160	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KA	0	250	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400KG	0	400	kPa	1600	-	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600KG	0	600	kPa	1600	-	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
800KG	0	800	kPa	1600	-	2500	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001GG	0	1	MPa	1.6	-	2.5	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.2GG	0	1.2	MPa	1.6	-	2.5	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Diff	erential						
025KD	-25	25	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
040KD	-40	40	kPa	1600	-	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
060KD	-60	60	kPa	1600	-	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	А
100KD	-100	100	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
160KD	-160	160	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KD	-250	250	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400KD	-400	400	kPa	1600	-	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							C	age						
060KG	0	60	kPa	1600	-	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
100KG	0	100	kPa	1600	_	2500	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
160KG	0	160	kPa	1600	-	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KG	0	250	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
400KG	0	400	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600KG	0	600	kPa	1600	-	2500	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
800KG	0	800	kPa	1600	_	2500	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001GG	0	1	MPa	1.6	_	2.5	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.2GG	0	1.2	MPa	1.6	_	2.5	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

ABP2 SERIES

TABLE 17. PRESSURE RANGE SPECIFICATIONS: 1PSI TO 175 PSI FOR PRODUCT OPTIONS "N","D","T" AND "V" ONLY PRESSURE RANGE SPECIFICATIONS: 2 INH,0 TO 1 PSI FOR PRODUCT OPTIONS "N" AND "D" ONLY

PRESS	Pres	ssure				NП ₂ U I (FUR PRUD	_	al Error B			NEI	
		nge		Overp	ressure ¹	Burst P	ressure ²			(%FSS		Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max} .	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Common Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digital Versions
							Ak	solute						
015PA	0	15	psi	240	-	375	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
030PA	0	30	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
							Diff	ferential						
002ND	-2	2	inH ₂ 0	270	270	2800	415	_	±2.0	±3.5	_	±1.0	±0.3	В
004ND	-4	4	inH ₂ 0	270	270	2800	415	_	±2.0	±3.5	_	±1.0	±0.3	В
005ND	-5	5	inH ₂ 0	270	270	2800	415	_	±2.0	±3.5	-	±1.0	±0.3	А
010ND	-10	10	inH ₂ 0	270	270	2800	415	_	±2.0	±3.5	_	±1.0	±0.3	А
020ND	-20	20	inH ₂ 0	830	415	2800	830	830	±1.5	±3.0	±4.5	±1.0	±0.2	А
030ND	-30	30	inH ₂ 0	830	415	2800	830	830	±1.5	±3.0	±4.5	±1.0	±0.2	А
001PD	-1	1	psi	30	15	100	30	30	±1.5	±3.0	±4.5	±1.0	±0.2	А
005PD	-5	5	psi	240	_	375	_	240	±1.5	±3.0	±4.5	±1.0	±0.6	Α
015PD	-15	15	psi	240	_	375	_	240	±1.5	±3.0	±4.5	±1.0	±0.2	Α
030PD	-30	30	psi	240	_	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.2	Α
060PD	-60	60	psi	240	_	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.2	Α
							(Gage						
004NG	0	4	inH ₂ 0	270	_	2800	-	_	±2.0	±3.5	-	±1.0	±0.3	В
005NG	0	5	inH ₂ 0	270	_	2800	_	_	±2.0	±3.5	_	±1.0	±0.3	В
010NG	0	10	inH ₂ 0	270	_	2800	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
020NG	0	20	inH ₂ 0	270	_	2800	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
030NG	0	30	inH ₂ 0	830	_	2800	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
001PG	0	1	psi	30	_	100	-	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
005PG	0	5	psi	30	-	100	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
015PG	0	15	psi	240	_	375	-	_	±1.5	±3.0	±4.5	±1.0	±0.5	Α
030PG	0	30	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
060PG	0	60	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
100PG	0	100	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
150PG	0	150	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
175PG	0	175	psi	240	_	375	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴ Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

		sure nge		Overp	essure¹	Burst P	ressure ²	Common	Tota	l Error Ba (%FSS)	and ⁴	Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (%FSS)	Stability (1000 HR) (%FSS)	Function for Digital Versions
							A	bsolute						
015PA	0	15	psi	240	-	375	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
030PA	0	30	psi	240	-	375	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
060PA	0	60	psi	240	-	375	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
LOOPA	0	100	psi	240	_	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
L50PA	0	150	psi	240	-	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
L75PA	0	175	psi	240	_	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Dif	ferential						
005PD	-5	5	psi	240	-	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.5	Α
015PD	-15	15	psi	240	_	375	_	240	±2.0	±3.0	±4.5	±1.0	±0.5	Α
030PD	-30	30	psi	240	-	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.5	А
060PD	-60	60	psi	240	_	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.5	Α
								Gage						
015PG	0	15	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
030PG	0	30	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
060PG	0	60	psi	240	-	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
LOOPG	0	100	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
L50PG	0	150	psi	240	-	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
175PG	0	175	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	А

¹ **Overpressure:** The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴ Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

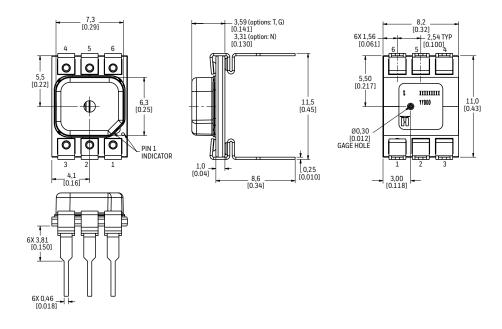
ABP2 SERIES

DIMENSIONAL DRAWINGS

Figure 9. DIP Package Dimensional Drawings (For reference only: mm [in].)

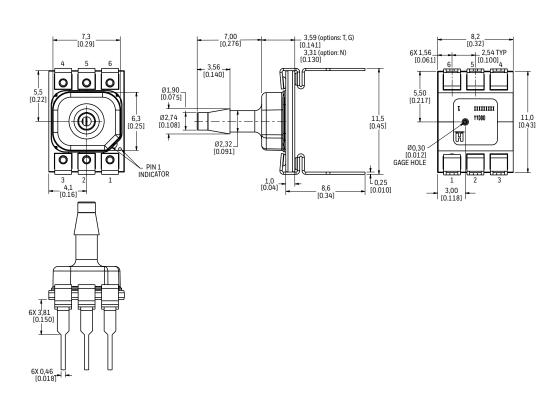
DIP NN: Plastic no port





DIP AN: Plastic single axial barbed port

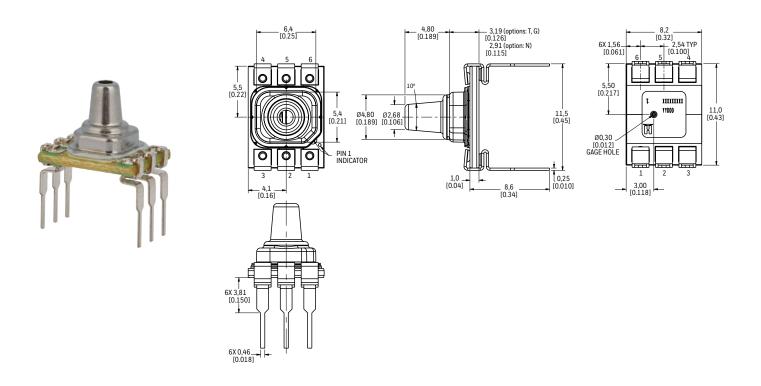




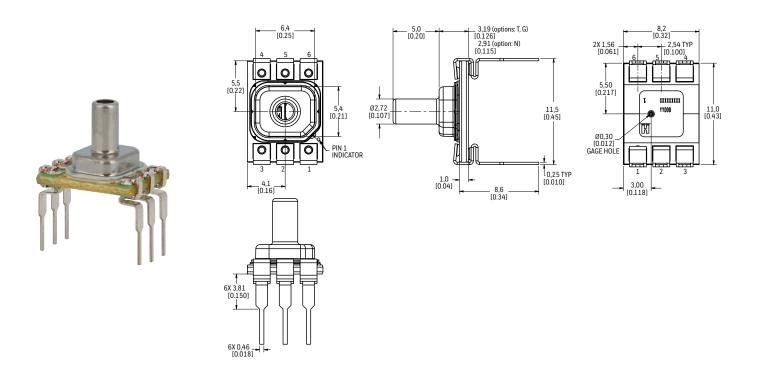
ABP2 SERIES

Figure 9. DIP Package Dimensional Drawings (Continued)

DIP VN: Metal single axial barbless port



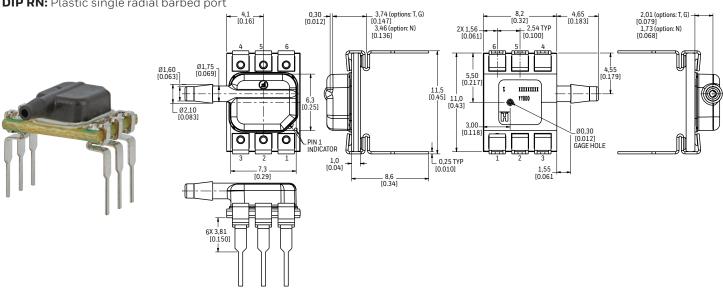
DIP SN: Metal single axial straight barbless port



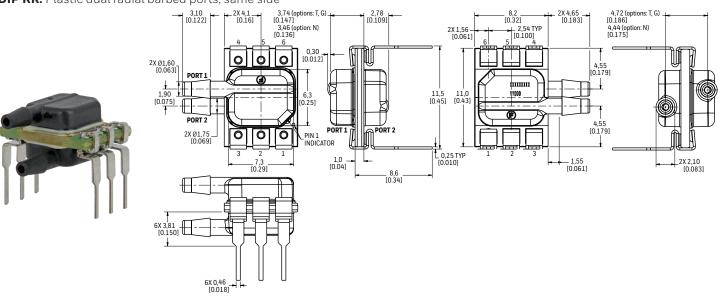
ABP2 SERIES

Figure 9. DIP Package Dimensional Drawings (Continued)

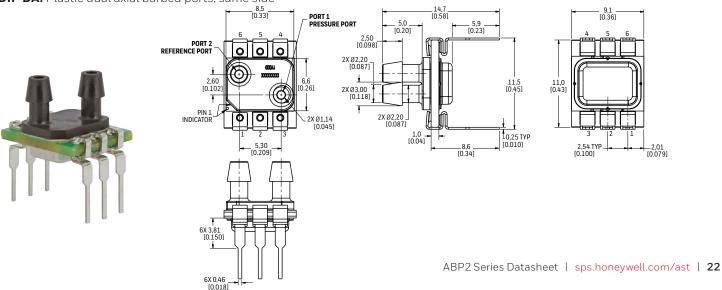
DIP RN: Plastic single radial barbed port



DIP RR: Plastic dual radial barbed ports, same side



DIP DA: Plastic dual axial barbed ports, same side

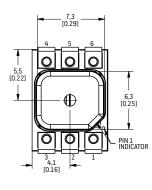


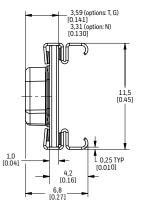
ABP2 SERIES

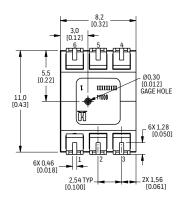
Figure 10. SMT Package Dimensional Drawings (For reference only: mm [in].)

SMT NN: Plastic no port



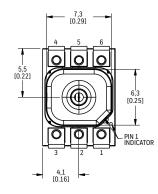


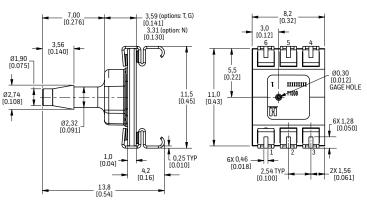




SMT AN: Plastic single axial barbed port

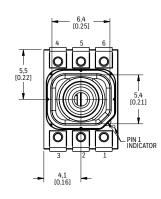


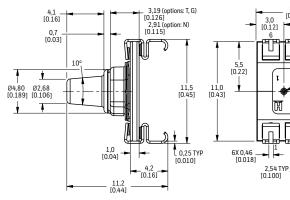




SMT VN: Metal single axial barbless port

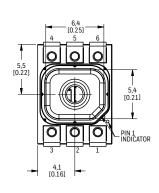


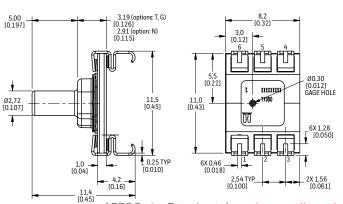




SMT SN: Metal single axial straight barbless port







_ Ø0,30 [0.012] GAGE HOLE

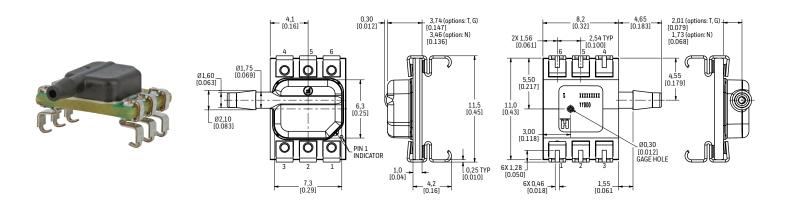
2X 1,56 [0.061]

шш

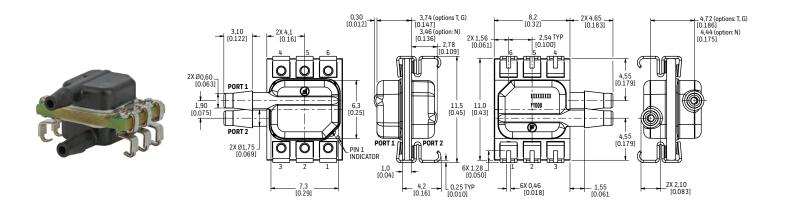
ABP2 SERIES

Figure 10. SMT Package Dimensional Drawings (Continued)

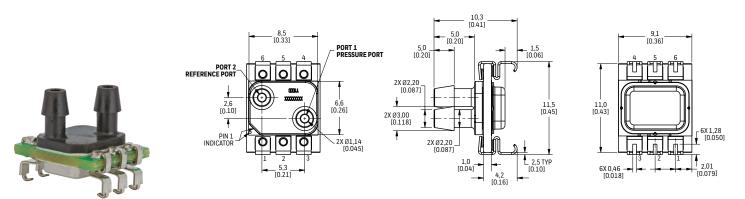
SMT RN: Plastic single radial barbed port



SMT RR: Plastic dual radial barbed ports, same side



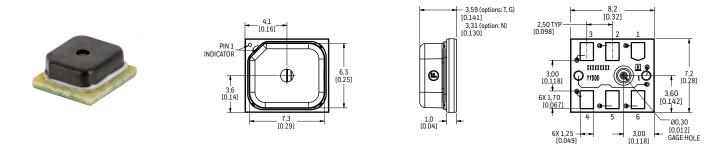
SMT DA: Plastic dual axial barbed ports, same side



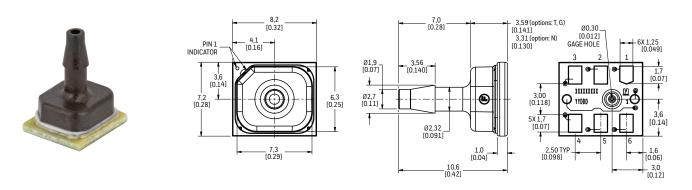
ABP2 SERIES

Figure 11. Leadless SMT Package Dimensional Drawings (For Reference Only: mm [in].)

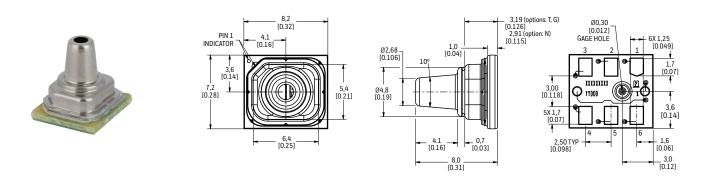
Leadless SMT NN: Plastic no port



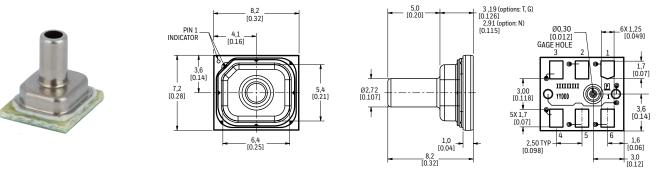
Leadless SMT AN: Plastic single axial barbed port



Leadless SMT VN: Metal single axial barbless port



Leadless SMT SN: Metal single axial straight port

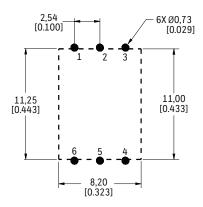


ABP2 SERIES

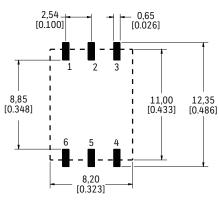
TABLE 19. PINOUT						
Output Type	Pin 1	Pin 2	Pin 3	Pin 4	Pin 5	Pin 6
I ² C	GND	V_{DD}	EOC	NC	SDA	SCL
SPI	GND	V_{DD}	MISO	SS	MOSI	SCLK
Analog	GND	NC	V_{OUT}	NC	NC	V_{DD}

Figure 12. Recommended PCB Layout and Part Marketing Details

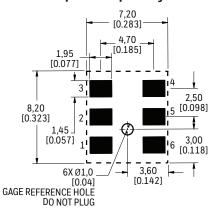
DIP Packages All pressure port styles except DA



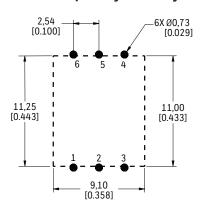
SMT Packages All pressure port styles except DA



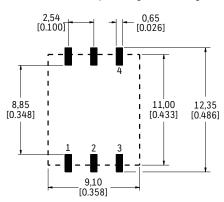
Leadless SMT Packages All pressure port styles



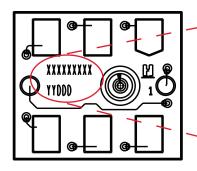
DIP Packages Pressure port style DA only



DMT Packages Pressure port style DA only



Part Marking Details



CATALOG LISTING: 'XXXXXXXXX'

EXAMPLE: N010BAA3

N - DRY GASES ONLY NO DIAGNOSTICS, 010B - 10bar, A - ABSOLUTE, A - ANALOG,

A - 10 % to 90 % of 2^24 COUNTS (DIGITAL). 3 - 3.3Vdc

DATE CODE: 'YYDDD' EXAMPLE: 19215

19 - YY - YEAR, 215 - DDD - JULIAN DAY.

ABP2 SERIES

1.0 **GENERAL INFORMATION**

Please see Figures 7, 8, and 9 for product dimensions and pinout details.

PINOUT AND FUNCTIONALITY 2.0

TABLE 20	TABLE 20. PINOUT AND FUNCTIONALITY										
Pad	I ² C Senso	or	SPI Sens	or							
Number	Name	Description	Name	Description							
1	GND	Ground reference voltage signal	GND	Ground reference voltage signal							
2	V_{DD}	Positive supply voltage	V_{DD}	Positive supply voltage							
3	EOC¹	End-of-conversion indicator: This pin is set high when a measurement and calculation have been completed and the data is ready to be clocked out	MISO	Master In/Sensor Out: Data output							
4	NC	No connection	SS	Sensor Select: Chip select							
5	SDA	Data in/out	MOSI	Master Out/Sensor In: Data in							
6	SCL	Clock input	SCLK	Clock input							

 $^{^{1}}$ For more details on EOC functionality, please refer to the technical note.

3.0 **START-UP TIMING**

On power-up, the ABP2 Series digital sensor is able to receive the first command after 2.5 ms from when the V_{DD} supply is within operating specifications.

4.0 **POWER SUPPLY REQUIREMENT**

Verify that system power to the sensor meets the V_{DD} rising slope requirement (minimum V_{DD} rising slope is at least 10 V/ms).

ABP2 SERIES

REFERENCE CIRCUIT DESIGNS 5.0

5.1 **DIGITAL OUTPUT VERSIONS**

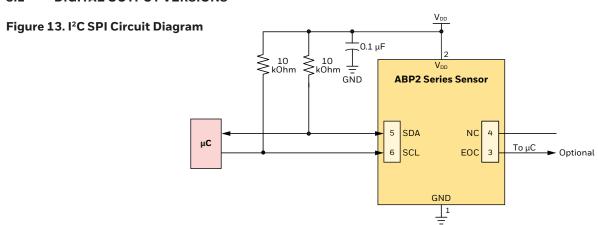
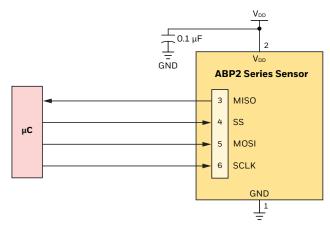
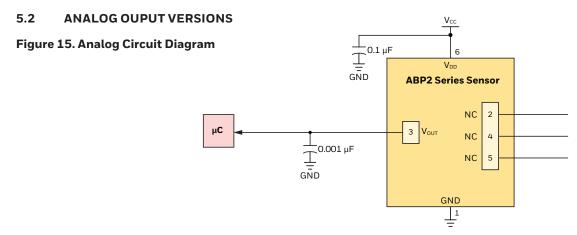


Figure 14. SPI Circuit Diagram





BYPASS CAPACITOR USE 5.3

NOTICE

To ensure output noise suppression, place an external bypass capacitor of $0.1~\mu\text{F}$ very close to the sensor power supply pin (see Figures 13 and 14) in the end-user design.

ABP2 SERIES

I²C COMMUNICATIONS 6.0

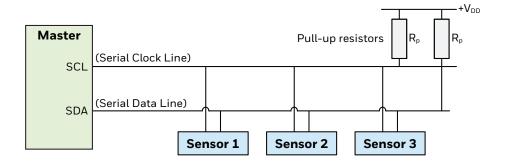
6.1 I²C BUS CONFIGURATION (SEE FIGURE 16.)

The I²C bus is a simple, serial 8-bit oriented computer bus for efficient I²C (Inter-IC) control. It provides good support for communication between different ICs across short circuit-board distances, such as interfacing microcontrollers with various low speed peripheral devices. For detailed specifications of the I²C protocol, see Version 6 (April 2014) of the I²C Bus Specification (source: NXP Semiconductor at https://www.nxp.com/docs/en/user-guide/UM10204.pdf).

Each device connected to the bus is software addressable by a unique address and a simple Master/Sensor relationship that exists at all times. The output stages of devices connected to the bus are designed around an open collector architecture. Because of this, pull-up resistors to $+V_{DD}$ must be provided on the bus. Both SDA and SCL are bidirectional lines, and it is important to system performance to match the capacitive loads on both lines. In addition, in accordance with the I²C specification, the maximum allowable capacitance on either line is 400 pF to ensure reliable edge transitions at 400 kHz clock speeds.

When the bus is free, both lines are pulled up to $+V_{DD}$. Data on the I^2C bus can be transferred at a rate up to 100 kbit/s in the standard-mode, or up to 400 kbit/s in the fast-mode.

Figure 16. I²C Bus Configuration



6.2 I²C DATA TRANSFER

The ABP2 Series I²C sensors are designed to respond to requests from a Master device. Following the address and read bit from the Master, the ABP2 Series digital output pressure sensors are designed to output up to 7 bytes of data. The first data byte is the Status Byte (8 bit), the second to fourth bytes are the compensated pressure output (24 bit) and the fifth to seventh bytes are the compensated temperature output (24 bit).

6.3 I²C SENSOR ADDRESS

Each ABP2 Series I²C sensor is referenced on the bus by a 7-bit Sensor address. The default address for the ABP2 Series is 40 (28 hex). Other available standard addresses are: 08 (08 hex), 24 (18 hex), 56 (38 hex), 72 (48 hex), 88 (58 hex), 104 (68 hex), 120 (78 hex). (Other custom values are available. Please contact Honeywell Customer Service with questions regarding custom Sensor addresses.)

I²C PRESSURE AND TEMPERATURE READING 6.4

To read out the compensated pressure and temperature reading, the Master generates a START condition and sends the Sensor address followed by a read bit (1). After the Sensor generates an acknowledge, it will transmit up to 7 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24 bit) and the fifth to seventh bytes are the compensated temperature output (24 bit). The Master must acknowledge the receipt of each byte, and can terminate the communication by sending a Not Acknowledge (NACK) bit followed by a Stop bit after receiving the required bytes of data.

ABP2 SERIES

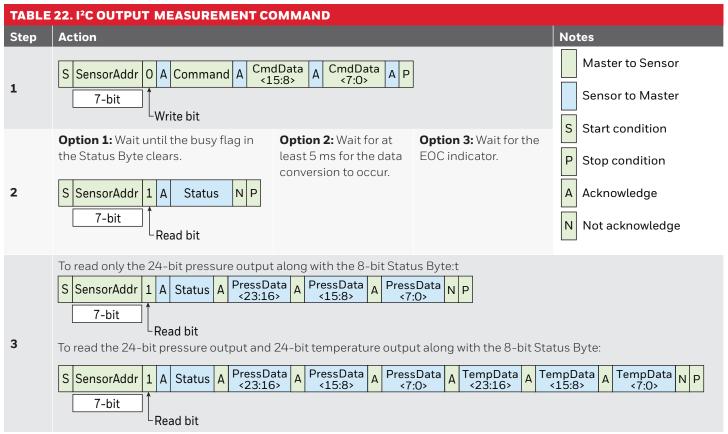
6.5 I²C STATUS BYTE

TABLE 21. I ² C STATUS BYTE	EXPLANATION	
BIT (Meaning)	Status	Comment
7	Always 0	_
6 (Power indication)	1 = device is powered 0 = device is not powered	_
5 (Busy flag)	1 = device is busy	Indicates that the data for the last command is not yet available. No new commands are processed if the device is busy.
4	Always 0	_
3	Always 0	_
2 (Memory integrity/error flag)	O = integrity test passed 1 = integrity test failed	Indicates whether the checksum-based integrity check passed or failed; the memory error status bit is calculated only during the power-up sequence.
1	Always 0	_
0 (Math saturation)	1 = internal math saturation has occurred	_

6.6 I²C COMMUNICATIONS

I²C OUTPUT MEASUREMENT COMMAND 6.6.1

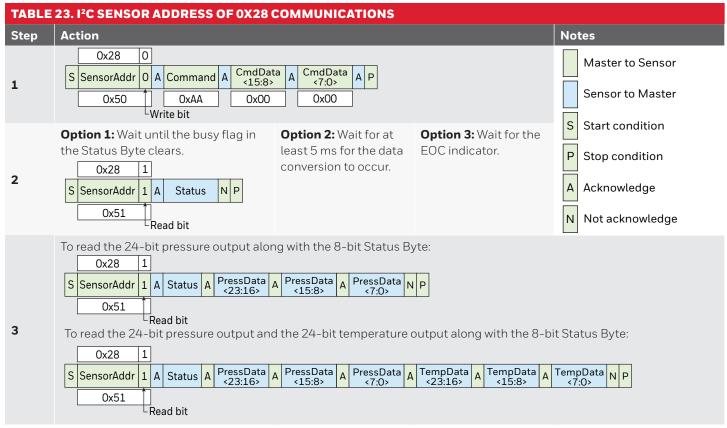
To communicate with the ABP2 Series I²C output sensor using an Output Measurement Command of "0xAA", followed by "0x00" "0x00", follow the steps shown in Table 22. This command will cause the device to exit Standby Mode and enter Operating Mode. At the conclusion of the measurement cycle, the device will automatically re-enter Standby Mode.



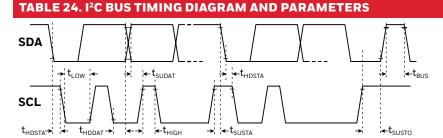
ABP2 SERIES

6.6.2 I²C SENSOR ADDRESS OF 0X28

To communicate with the ABP2 Series I^2C output sensor with an I^2C Sensor Address of 0x28 (hex), follow the steps shown in Table 23.



6.7 I²C TIMING AND LEVEL PARAMETERS



Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCL clock frequency	f _{SCL}	100	_	400	kHz
Start condition hold time relative to SCL edge	t _{HDSTA}	0.1	_	_	μs
Minimum SCL clock low width ¹	t _{LOW}	0.6	_	_	μs
Minimum SCL clock high width ¹	t _{HIGH}	0.6	_	_	μs
Start condition setup time relative to SCL edge	t _{SUSTA}	0.1	_	_	μs
Data hold time on SDA relative to SCL edge	t _{HDDAT}	0	_	_	μs
Data setup time on SDA relative to SCL edge	t _{SUDAT}	0.1	_	_	μs
Stop condition setup time on SCL	t _{susto}	0.1	_	_	μs
Bus free time between stop condition and start condition	t _{BUS}	2	_	_	μs
Output level low	Out _{low}	_	0	0.2	V_{DD}
Output level high	Out _{high}	0.8	1	_	V_{DD}
Pull-up resistance on SDA and SCL	R_p	1	_	50	kOhm

¹ Combined low and high widths must equal or exceed minimum SCL period.

ABP2 SERIES

REFERENCE CODE (ARDUINO/GENUINO UNO) FOR I²C INTERFACE

See also Section 8.0 for details and examples of ABP2 Series Pressure and Temperature output calculations.

```
#include<Arduino.h>
#include<Wire.h>
uint8_t id = 0x28; // i2c address
uint8_t data[7]; // holds output data
uint8_t cmd[3] = \{0xAA, 0x00, 0x00\}; // command to be sent
double press_counts = 0; // digital pressure reading [counts]
double temp_counts = 0; // digital temperature reading [counts]
double pressure = 0; // pressure reading [bar, psi, kPa, etc.]
double temperature = 0; // temperature reading in deg C
double outputmax = 15099494; // output at maximum pressure [counts]
double outputmin = 1677722; // output at minimum pressure [counts]
double pmax = 1; // maximum value of pressure range [bar, psi, kPa, etc.]
double pmin = 0; // minimum value of pressure range [bar, psi, kPa, etc.]
double percentage = 0; // holds percentage of full scale data
char printBuffer[200], cBuff[20], percBuff[20], pBuff[20], tBuff[20];
void setup() {
  Serial.begin(9600);
  while (!Serial) {
    delay(10);
  Wire.begin();
  sprintf(printBuffer, "\nStatus Register, 24 - bit Sensor data, Digital Pressure Counts,\)
           Percentage of full scale pressure, Pressure Output, Temperature\n");
  Serial.println(printBuffer);
void loop() {
  Wire.beginTransmission(id);
  int stat = Wire.write (cmd, 3); // write command to the sensor
  stat |= Wire.endTransmission();
  delay(10);
  Wire.requestFrom(id, 7); // read back Sensor data 7 bytes
  int i = 0;
  for (i = 0; i < 7; i++) {
    data [i] = Wire.read();
  press_counts = data[3] + data[2] * 256 + data[1] * 65536; // calculate digital pressure counts
  temp_counts = data[6] + data[5] * 256 + data[4] * 65536; // calculate digital temperature counts
temperature = (temp_counts * 200 / 16777215) - 50; // calculate temperature in deg c
  percentage = (press_counts / 16777215) * 100; // calculate pressure as percentage of full scale
  //calculation of pressure value according to equation 2 of datasheet
  pressure = ((press_counts - outputmin) * (pmax - pmin)) / (outputmax - outputmin) + pmin;
  dtostrf(press_counts, 4, 1, cBuff);
  dtostrf(percentage, 4, 3, percBuff);
  dtostrf(pressure, 4, 3, pBuff);
  dtostrf(temperature, 4, 3, tBuff);
    The below code prints the raw data as well as the processed data
    Data format : Status Register, 24-bit Sensor Data, Digital Counts, percentage of full scale
pressure,
    pressure output, temperature
  sprintf(printBuffer, " % x\t % 2x % 2x % 2x\t % s\t % s\t % s\t % s \n", data[0], data[1], data[2],
          data[3],
          cBuff, percBuff, pBuff, tBuff);
  Serial.print(printBuffer);
  delay(10);
```

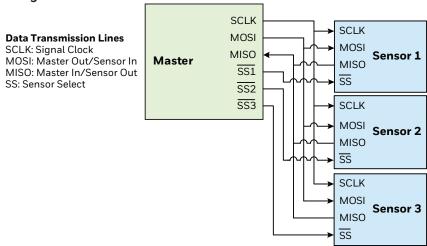
ABP2 SERIES

7.0 **SPI COMMUNICATIONS**

7.1 **SPI DEFINITION**

The Serial Peripheral Interface (SPI) is a simple bus system for synchronous serial communication between one Master and one or more Sensors. It operates either in full-duplex or half-duplex mode, allowing communication to occur in either both directions simultaneously, or in one direction only. The Master device initiates an information transfer on the bus and generates clock and control signals. Sensor devices are controlled by the Master through individual Sensors Select (SS) lines and are active only when selected. The ABP2 Series SPI sensors operate in full-duplex mode only, with data transfer from the Sensors to the Master. This data transmission uses four, unidirectional bus lines. The Master controls SCLK, MOSI and SS; the Sensor controls MISO. (See Figure 17.)

Figure 17. SPI Bus Configuration



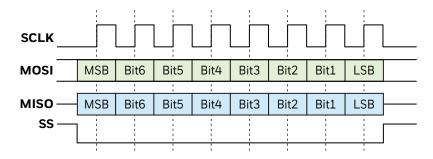
IMPORTANT:

If more than one ABP2 sensor, or other SPI slave devices, or more than one Master, are connected to the same SPI bus, before very first transaction on the SPI bus, bring SS line of each ABP2 sensor from High state to Low state, hold the Low state for minimum of 200 us, and release it to High state.

7.2 **SPI DATA TRANSFER**

Communicate with the ABP2 Series SPI sensors by de-asserting the Sensor Select (SS) line. At this point, the sensor is no longer idle, and will begin sending data once a clock is received. ABP2 Series SPI sensors are configured for SPI operation in mode 0 (clock polarity is 0 and clock phase is 0). (See Figure 18.)

Figure 18. Example of 1 Byte SPI Data Transfer



Once the clocking begins, the ABP2 Series SPI sensor is designed to output up to 7 bytes of data. The first data byte is the Status Byte (8-bit), the second to fourth bytes are the compensated pressure output (24-bit) and the fifth to seventh bytes are the compensated temperature output (24-bit).

ABP2 SERIES

7.3 SPI PRESSURE AND TEMPERATURE READING

To read out the compensated pressure and temperature reading, the Master generates the necessary clock signal after activating the sensor with the Sensor Select (SS) line. The sensor will transmit up to 7 bytes of data. The first data byte is the Status Byte (8-bit), the second to fourth bytes are the compensated pressure output (24-bit) and the fifth to seventh bytes are the compensated temperature output (24-bit). The Master can terminate the communication by stopping the clock and deactivating the SS line.

7.4 **SPI STATUS BYTE**

The SPI status byte contains the bits shown in Table 25.

TABLE 25. SPI STATUS BYTE E	EXPLANATION	
Bit (Meaning)	Status	Comment
7	Always 0	_
6 (Power indication)	1 = device is powered 0 = device is not powered	_
5 (Busy flag)	1 = device is busy	Indicates that the data for the last command is not yet available. No new commands are processed if the device is busy.
4	Always 0	_
3	Always 0	_
2 (Memory integrity/error flag)	0 = integrity test passed 1 = integrity test failed	Indicates whether the checksum-based integrity check passed or failed; the memory error status bit is calculated only during the power-up sequence.
1	Always 0	_
0 (Math saturation)	1 = internal math saturation has occurred	_

ABP2 SERIES

7.5 **SPI COMMUNICATION**

To communicate with the ABP2 Series SPI output sensor using an Output Measurement Command of "OxAA", followed by "0x00" "0x00", follow the steps shown in Table 26. This command will cause the device to exit Standby Mode and enter Operating Mode. At the conclusion of the measurement cycle, the device will automatically re-enter Standby Mode.

TABLE	26. SPI	OUTPUT	MEASUR	EMENT	COMMAN	ID _				
Step	Action							Notes		
1	MOSI MISO	e data on MISO depend on the preceding command. Discard the data on the MISO line. OXAA							Master to Sensor Sensor to Master NOP Command is "0xF0".	
2	MOSI MISO	1: Wait unt OxFO Command = NOP Status	il the busy	flag in the	Status By	te clears.	Option	2: Wait for a	at least 5 ms fo	or the data conversion to occur.
3	MOSI MISO	Only the 2 OxFO Command = NOP Status the 24-bit OxFO Command = NOP Status	Ox00 OO _{Hex} PressData <24:16>	Ox00 OO _{Hex} PressData <15:8>	Ox00 O0Hex PressData <7:0> d the 24- Ox00 O0Hex	bit temper 0x00	rature out 0x00 00 _{Hex}	put along v 0x00 00 _{Hex}	vith the 8-bit	Status Byte:

ABP2 SERIES

7.6 **SPI TIMING AND LEVEL PARAMETERS**

TABLE 27. SPI BUS TIMING DIAGRAM AND PARAMETERS **SCLK** MOSI/MISO HiZ HiZ $\leftarrow\!t_{\text{CLKD}}$ ss

Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCLK clock frequency	f _{SCLK}	50	_	800	kHz
SS drop to first clock edge	t _{HDSS}	2.5	_	_	μs
Minimum SCLK clock low width ¹	t _{LOW}	0.6	_	_	μs
Minimum SCLK clock high width ¹	t _{HIGH}	0.6	_	_	μs
Clock edge to data transition	t _{CLKD}	0	_	_	μs
Rise of SS relative to last clock edge	t _{suss}	0.1	_	_	μs
Bus free time between rise and fall of SS	t _{BUS}	2	_	_	μs
Output level low	Out _{low}	_	0	0.2	V_{DD}
Output level high	Out _{high}	0.8	1	_	V_{DD}

¹Combined low and high widths must equal or exceed minimum SCLK period.

ABP2 SERIES

7.7 REFERENCE CODE (ARDUINO/GENUINO UNO) FOR SPI INTERFACE

See also Section 8.0 for details and examples of ABP2 Series Pressure and Temperature output calculations.

```
#include<Arduino.h>
#include<SPI.h>
double press_counts = 0; // digital pressure reading [counts]
double temp_counts = 0; // digital temperature reading [counts]
double pressure = 0; // pressure reading [bar, psi, kPa, etc.]
double temperature = 0; // temperature reading in deg C
double outputmax = 15099494; // output at maximum pressure [counts]
double outputmin = 1677722; // output at minimum pressure [counts]
double pmax = 1; // maximum value of pressure range [bar, psi, kPa, etc.]
double pmin = 0; // minimum value of pressure range [bar, psi, kPa, etc.]
double percentage = 0; // holds percentage of full scale data
char printBuffer[200], cBuff[20], percBuff[20], pBuff[20], tBuff[20];
void setup() {
  Serial.begin(9600);
  while (!Serial) {
    delay(10);
  sprintf(printBuffer, "\nStatus Register, 24-bit Sensor data, Digital Pressure Counts,\
  Percentage of full scale pressure, Pressure Output, Temperature \n");
  Serial.println(printBuffer);
  SPI.begin();
  pinMode(10, OUTPUT); // pin 10 as SS
  digitalWrite(10, HIGH); // set SS High
void loop() {
  delay(1);
  while (1) {
    uint8 t data[7] = {0xF0, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00}; // holds output data
    uint8 t cmd[3] = \{0xAA, 0x00, 0x00\}; // command to be sent
    SPI.beginTransaction(SPISettings(200000, MSBFIRST, SPI MODE0)); //SPI at 200kHz
    digitalWrite(10, LOW); // set SS Low
    SPI.transfer(cmd, 3); // send Read Command
    digitalWrite(10, HIGH); // set SS High
    delay(10); // wait for conversion
    digitalWrite(10, LOW);
    SPI.transfer(data, 7);
    digitalWrite(10, HIGH);
    SPI.endTransaction();
    press_counts = data[3] + data[2] * 256 + data[1] * 65536; // calculate digital pressure counts
    temp_counts = data[6] + data[5] * 256 + data[4] * 65536; // calculate digital temperature counts
    temperature = (temp_counts * 200 / 16777215) - 50; // calculate temperature in deg c
    percentage = (press_counts / 16777215) * 100; // calculate pressure as percentage of full scale
    //calculation of pressure value according to equation 2 of datasheet
    pressure = ((press counts - outputmin) * (pmax - pmin)) / (outputmax - outputmin) + pmin;
    dtostrf(press_counts, 4, 1, cBuff);
    dtostrf(percentage, 4, 3, percBuff);
    dtostrf(pressure, 4, 3, pBuff);
    dtostrf(temperature, 4, 3, tBuff);
     The below code prints the raw data as well as the processed data
     Data format : Status Register, 24-bit Sensor Data, Digital Counts, percentage of full scale pressure,
pressure output,
     temperature
    sprintf(printBuffer, "%x\t%2x %2x \t%s\t%s\t%s\t%s \n", data[0], data[1], data[2], data[3],
            cBuff, percBuff, pBuff, tBuff);
    Serial.print(printBuffer);
    delay(10);
press counts = (double)((int32 t)data[3]+(int32 t)data[2]*(int32 t)256+ (int32 t)data[1]*(int32 t)65536);
```

ABP2 SERIES

8.0 **ABP2 SERIES CALCULATIONS**

DIGITAL OUTPUT VERSIONS 8.1

8.1.1 **Pressure Output**

The ABP2 Series sensor pressure output may be expressed by the transfer function of the device as shown in Equation 1:

Equation 1: Pressure Sensor Transfer Function

Output =
$$\frac{\text{Output}_{\text{max}} - \text{Output}_{\text{min.}}}{P_{\text{max}} - P_{\text{min.}}} * (\text{Pressure} - P_{\text{min.}}) * \text{Output}_{\text{min.}}$$

Rearranging this equation to solve for Pressure provides Equation 2:

Equation 2: Pressure Output Function

Pressure =
$$\frac{(Output - Output_{min.}) * (P_{max.} - P_{min.})}{Output_{max.} - Output_{min.}} + P_{min.}$$

Where:

Output_{max.} = output at maximum pressure [counts]

Output_{min.} = output at minimum pressure [counts]

P_{max.} = maximum value of pressure range [bar, psi, kPa, etc.]

P_{min.} = minimum value of pressure range [bar, psi, kPa, etc.]

Pressure = pressure reading [bar, psi, kPa, etc.]

Output = digital pressure reading [counts]

Example: Calculate the pressure for a -1 psi to 1 psi gage sensor with a 10 to 90 calibration, and a pressure output of 14260634 (decimal) counts:

Output_{max.} = 15099494 counts (90 of 2^{24} counts or 0xE66666)

Output_{min} = 1677722 counts (10 of 2^{24} counts or 0x19999A)

 $P_{max.} = 1 psi$

 $P_{min} = -1 psi$

Pressure = calculated pressure in psi

Output = 14260634 counts

Pressure =
$$\left(\frac{(2.805 - 0.33 * (1 - (-1)))}{2.97 - 0.33}\right) + (-1)$$

Pressure =
$$\left(\frac{25165824}{13421772}\right) + (-1)$$

Pressure = 0.875 psi

ABP2 SERIES

8.1.2 Temperature Output

The ABP2 Series sensor temperature output may be expressed by the transfer function of the device as shown in Equation 3:

Equation 3: Temperature Output Transfer Function

Temperature =
$$\frac{T_{out} * (T_{max.} - T_{min.})}{(2^{(24)} - 1)} + T_{min.}$$

Where:

Temperature = calculated temperature output in °C

T_{out} = digital temperature output in counts (decimal)

 $T_{\text{max.}} = 85^{\circ}\text{C}$

 $T_{min} = -40^{\circ}C$

Example: Calculate the temperature for a temperature output of 8724152 (decimal) counts.

Temperature =
$$\frac{T_{out} * (85 - (-40))}{(2^{(24)} - 1)} + T_{min.}$$

Temperature =
$$\frac{8724152 \times 125}{16777215} - 40$$

Temperature = 25°C

ABP2 SERIES

8.2 **ANALOG OUTPUT VERSIONS**

The ABP2 Series sensor temperature output may be expressed by the transfer function of the device as shown in Equation 1:

Equation 1: Pressure Output Transfer Function

Output =
$$\frac{Output_{max.} - Output_{min.}}{P_{max.} - P_{min.}} * (Pressure - P_{min.}) + Output_{min.}$$

Pressure =
$$\frac{(Output - Output_{min.}) * (P_{max.} - P_{min.})}{Output_{max.} - Output_{min.}} + P_{min.}$$

Where:

 $Output_{max}$ = output at maximum pressure [Vdc]

Output_{min.} = output at minimum pressure [Vdc]

P_{max} = maximum value of pressure range [bar, psi, kPa, etc.]

P_{min.} = minimum value of pressure range [bar, psi, kPa, etc.]

Pressure = pressure reading [bar, psi, kPa, etc.]

Output = digital pressure reading [Vdc]

Example: Calculate the pressure for a -1 psi to 1 psi gage sensor with a 10 % to 90 % calibration, and a pressure output of 2.805 Vdc at 3.3 Vdc supply voltage:

$$Output_{max.} = 2.97 \, Vdc (90 \% of V_{supply})$$

Output_{min.} =
$$0.33 \, \text{Vdc} (10 \, \% \, \text{of} \, \text{V}_{\text{supply}})$$

$$P_{\text{max.}} = 1 \text{ psi}$$

$$P_{min.} = -1 psi$$

Pressure = pressure in psi

Output = 2.805 Vdc

Pressure =
$$\left(\frac{(2.805 - 0.33) * (1 - (-1))}{2.97 - 0.33}\right) + (-1)$$

Pressure =
$$\left(\frac{4.95}{2.64}\right)$$
 -1

Pressure = 0.875 psi

ABP2 SERIES

9.0 RECOMMENDED PNEUMATIC SENSOR CONNECTIONS

9.1

Tubing is a common method of pneumatically connecting to the sensors and needs to be matched to the sensor's application to provide the required operating temperature range and working pressure. Depending on the working pressure range and operating temperature, the corresponding type of tubing can be selected (i.e., Superthane®, silicone, and vinyl). Silicone tubing, for instance, tends to be the easiest to which to connect; however, its working pressure is not as high as that of the other materials.

The lower the shore rating for the tubing, the easier it is to insert the tubing onto the sensor's pressure port; however, the lower shore rated tubing also has lower working pressures. For working pressures of 20 psi and below, silicone or vinyl tubing tends to be used. For pressures above 20 psi, Superthane® or low-density polyethylene tubing may be considered. Table 28 shows recommended tubing for use with Honeywell's Basic Board Mount Pressure Sensors.

Generally, when the working pressure is 15 psi or less, clamps are typically not required. However, because each application is different, the end use must be taken into account before determining whether clamps are necessary to ensure that the tubing remains in place and doesn't leak. Considerations include vibration, pressure spikes, and the type of tubing being used. A common clamping method is to use a plastic cable tie, available in a variety of sizes and found in most hardware stores. They are relatively easy to install and stay in place over time.

NOTICE

Instead of using a clamp, a small drop of epoxy may be applied to either pressure port prior to the tubing being placed onto the port or applied at the end of the tubing once the tubing is in place. This method holds the tubing in place and can further act as a sealing agent to help ensure a leak-tight connection between the pressure port and the tubing. A room temperature sealant is generally used for this purpose. Ensure that the epoxy doesn't block the hole in the port as it needs to remain open.

NOTICE

To apply a more rigid tubing-to-port connection, a low-power heat gun may be used to slightly heat the tubing. Once cooled, the tubing tends to grip the pressure port better.

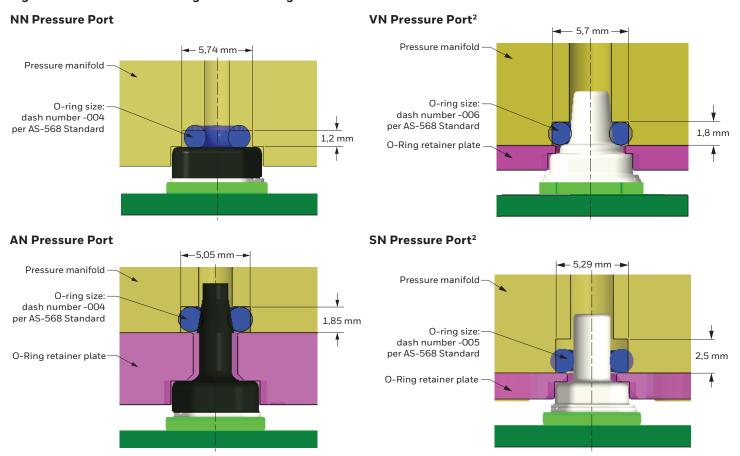
TABLE 28. RECOMMENDED TUBING								
Pressure Port	Manufacturer	Туре	Part Number	Part Number ID		Pressure at 25°C (psi)		
AN	Frelin-Wade	Fre-Thane® (polyurethane)	1A-156-11	0.093 in	0.156 in	210		
AN	Frelin-Wade	nylon	1A-200-01	0.093 in	0.125 in	270		
AN	NewAge Industries	PVC	1100225	0.094 in	0.156 in	42		
AN	NewAge Industries	silicone	2800315	0.094 in	0.156 in	20		
AN	McMaster	silicone	5041K512	2,0 mm	6,0 mm	60		
AN	McMaster	silicone	5041K601	2,0 mm	6,0 mm	115		
RN, RR	Frelin-Wade	Fre-Thane	95a-157	0.066 in	0.125 in	225		
RN, RR	NewAge Industries	Superthane® (ether)	2110535	0.066 in	0.125 in	135		
RN	NewAge Industries	silicone	2800161	0.063 in	0,188 in	20		
RN, RR	Du-Bro	silicone	196 1/16 ID	0.063 in	0.125 in	20		
RN, RR	US Plastics	Excelthane polyurethane	77901710	0.063 in	0.125 in	70		
RN, RR	McMaster	silicone	5041K603	1,0 mm	3.00 in	15		
DA	McMaster	silicone	5041K512	2,0 mm	6,0 mm	60		

ABP2 SERIES

9.2 **O-RING MANIFOLD DESIGNS**

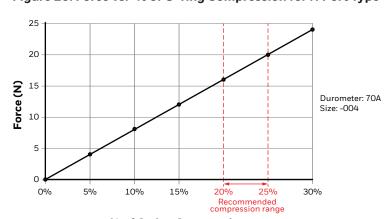
O-rings may also be used to connect pneumatically to the sensor. Most O-ring manufacturers recommend a compression of 20 % to 25 % to provide the proper O-ring compression over the temperature range. Silicone or fluorosilicone O-rings are commonly used as they tend to take less of a set over temperature verses other O-ring materials. System operating temperatures and sealant media compatibility are the two most important parameters which must be considered when selecting an O-ring base polymer. See Figures 19 and 20, and Table 29 for more information.

Figure 19. Guidelines for O-ring Manifold Designs¹



¹The recommended design has been validated for operating conditions ranging from -40°C to 110°C and up to 16 bar gage pressure.

Figure 20. Force vs. % of O-ring Compression for N Port Type



% of O-ring Compression

NOTICE

It is the buyer's sole responsibility to determine the suitability of the product in the application.

² For more demanding applications, a second O-ring can be used with a gland height of 3,6 mm (VN pressure port) and 4,55 mm (SN pressure port).

TABLE 29. RECOMMENDED O-RINGS								
Pressure Port	O-ring size AS-568 uniform dash numbers	O-ring ID (mm)	O-ring C/S (mm)	Material	Supplier	Part Number	Shore Hardness	
NN	-004	1,78	1,78	Fluoroelastomer	McMaster	8333T114	Durometer 70A	
NN	-004	1,78	1,78	Silicone	McMaster	1283N14	Durometer 70A	
AN	-004	1,78	1,78	Fluoroelastomer	McMaster	8333T114	Durometer 70A	
AN	-004	1,78	1,78	Silicone	McMaster	1283N14	Durometer 70A	
SN	-005	2,57	1,78	Fluoroelastomer	McMaster	8333T115	Durometer 70A	
SN	-005	2,57	1,78	Silicone	McMaster	1283N15	Durometer 70A	
VN	-006	2,90	1,78	Fluoroelastomer	McMaster	8333T116	Durometer 70A	
VN	-006	2,90	1,78	Silicone	McMaster	1283N16	Durometer 70A	

△ WARNINGPERSONAL INJURY

DO NOT USE these products as safety or emergency stop devices or in any other application where failure of the product could result in personal injury.

Failure to comply with these instructions could result in death or serious injury.

⚠ WARNINGMISUSE OF DOCUMENTATION

- The information presented in this product sheet is for reference only. Do not use this document as a product installation guide.
- Complete installation, operation, and maintenance information is provided in the instructions supplied with each product.

Failure to comply with these instructions could result in death or serious injury.

For more information

Honeywell Sensing & Safety
Technologies services its customers
through a worldwide network of sales
offices and distributors. For application
assistance, current specifications,
pricing or the nearest Authorized
Distributor, visit our website or call:

USA/Canada +1 302 613 4491 Latin America +1 305 805 8188 Europe +44 1344 238258 Japan +81 (0) 3-6730-7152 Singapore +65 6355 2828 Greater China +86 4006396841

WARRANTY/REMEDY

Honeywell warrants goods of its manufacture as being free of defective materials and faulty workmanship during the applicable warranty period. Honeywell's standard product warranty applies unless agreed to otherwise by Honeywell in writing; please refer to your order acknowledgment or consult your local sales office for specific warranty details. If warranted goods are returned to Honeywell during the period of coverage, Honeywell will repair or replace, at its option, without charge those items that Honeywell, in its sole discretion, finds defective.

The foregoing is buyer's sole remedy and is in lieu of all other warranties, expressed or implied, including those of merchantability and fitness for a particular purpose. In no event shall Honeywell be liable for consequential, special, or indirect damages.

While Honeywell may provide application assistance personally, through our literature and the Honeywell web site, it is buyer's sole responsibility to determine the suitability of the product in the application.

Specifications may change without notice. The information we supply is believed to be accurate and reliable as of this writing. However, Honeywell assumes no responsibility for its use.

Honeywell Sensing & Safety Technologies

830 East Arapaho Road Richardson, TX 75081 www.honeywell.com Fre-Thane® is a registered trademark of Freelin-Wade Co. Superthane® is a registered trademark of NewAge® Industries

